

苏州沃虎电子科技有限公司 Suzhou Voohu Electronic Technology Co., Ltd.

	Version change history					
Rev	Date	Description	Approved By			
1.0	2019/6/1	文件制定	Zhu Fan			











WHYT1265 Series

Introduction

- ROHS, Halogen Free and REACH compliance
- High rated current
- 125℃ maximum total temperature operation
- 13.8×12.9×6.5mm maximum surface mount package
- Low core loss
- Ultra low buzz noise due to molding construction

Applications

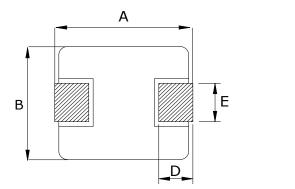
- Laptops and PCs
- Switch and servers
- Base stations
- DC/DC converters
- · Battery powered devices
- SSD modules

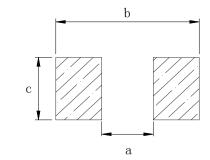
Product Identification

<u>WH</u>	<u>YT</u>	<u>1265</u>	<u>1R5</u>	M
(1)	2	3	(4)	(5)

- ① WH ----- Company Name Code
- 2 YT ----- Series Name
- ③ 1265 ----- Dimension
- (4) 1R5 ------ Inductance Value (1R5 = 1.5µH)
- (5) M -----Inductance Tolerance (M= ± 20%)

Dimensions (unit:mm)





Recommend Land Pattern

А	В	С	D	E	a typ	b typ	c typ
13.45±0.35	12.6±0.3	6.5MAX	2.0±0.5	5.0±0.3	8	14.5	5.5









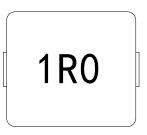


Marking

The inductor is marked with a 3-digit code

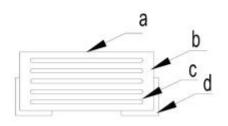
Nominal Inductance				
Example	Nominal Value			
1R0	1.0 µH			
100	10 µH			
101	100 µH			

Note : Using Ink for marking



Structure and Components

Symbol	Components	Material
а	MARKING	Ink(black)
b	CORE	Alloy Sponge Powder
с	WIRE	Polyurethane copper wire
d	Terminal	Copper plated with Sn









	Inductance	DC Resistance	Saturation Current	Heating Rating Current
Part No.	L0 (µH)	DCR (mΩ)	Isat (A)	Irms (A)
	±20 %, 100 kHz, 1V	MAX.	TYP.	TYP.
WHYT1265-4R7M-E50	4.7	8.5	24	16
WHYT1265-5R6M-E50	5.6	10.5	22.5	14
WHYT1265-6R8M-E50	6.8	12	19	13
WHYT1265-8R2M-E50	8.2	14	16	12
WHYT1265-100M-E50	10	16.5	15	11
WHYT1265-150M-E50	15	26	11	9.5
WHYT1265-220M-E50	22	36	9	8
WHYT1265-330M-E50	33	65	8	6.5
WHYT1265-470M-E50	47	70	6.8	5.5
WHYT1265-680M-E50	68	120	5.2	4.8
WHYT1265-820M-E50	82	135	4.5	4
WHYT1265-101M-E50	100	170	4	3.5

Notes

- 1. All test data is referenced to 25 °C ambient
- 2. Operating temperature range 55 °C to + 125 °C
- 3. Irms (A):DC current (A) that will cause an approximate ΔT of 40 °C(reference ambient temperature is 25 °C)
- 4. Isat(A):DC current (A) that will cause L0 to drop approximately 30 %
- 5. The part temperature (ambient + temp rise) should not exceed 125 °C under worst case operating conditions. Circuit design, component placement, PWB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.







VOOHU 沃虎

苏州沃虎电子科技有限公司 Suzhou Voohu Electronic Technology Co., Ltd.

Mechanical Relia	bility	
Item	Specification and Requirement	Test Method
Solderability	 No case deformation or change in apperarance New solder coverage More than 95% 	1.Preheat: 155℃±5℃, 60S±2S 2.Tin: lead-free. 3.Temperature:240℃±5℃, flux 3.0S±0.5S.
Mechanical shock	1. No case deformation or change in apperarance 2. $\triangle L/Lo \leq \pm 10\%$	 Acceleration: 100G Pulse time:: 6ms 3 times in each positive and negative direction of 3 mutual perpendicular directions
Mechanical vibration	 No case deformation or change in apperarance △L/Lo≦±10% 	 Reflow: 2times Frequency: 10HZ~55HZ~10HZ, 20 Min/Cycles Amplitude: 1.52 mm Directions: X,Y,Z Time: 12 cycle / direction
Endurance Relia	bility	
Item	Specification and Requirement	Test Method
Thermal Shock	Inductance change: Within \pm 10% Without distinct damage in appearance	 First -55°C for 30 minutes, last 125°C for 30 minutes as 1 cycle. Go through 1000 cycles. Max transfer time is 3 minutes. Measured at room temperature after placing for 24±2 hours
Humidity Resistance	Inductance change: Within \pm 10% Without distinct damage in appearance	 1.Reflow 2 times, 2.85℃,85%RH,1000 hours 3.Measured at room temperature after placing for 24±2 hours
Low temperature storage	Inductance change: Within \pm 10% Without distinct damage in appearance	 Temperature: -55 ± 2℃ Time: 1000 hours Measured at room temperature after placing for 24±2 hours
High temperature storage	Inductance change: Within \pm 10% Without distinct damage in appearance	 Temperature: +125 ± 2℃ Time: 1000 hours Measured at room temperature after placing for 24±2 hours







VOOHU 沃虎

Recommended Soldering Technologies

(1)Re-flowing Profile

Preheat condition: 150 ~200 $^\circ \mathrm{C}/60 \text{~-} 180 \text{sec.}$

Allowed time above $217^{\circ}C$: 80~120sec.

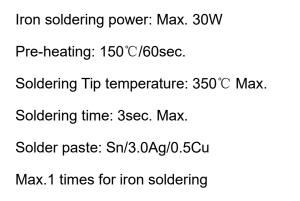
Max temp: 260°C

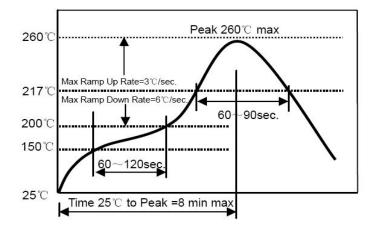
Max time at max temp: 10 sec.

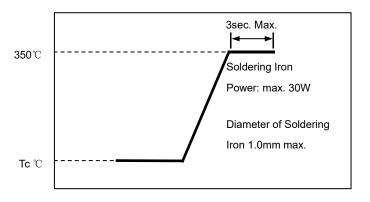
Solder paste: Sn/3.0Ag/0.5Cu

Allowed Reflow time: 2x max

(2) Iron Soldering Profile







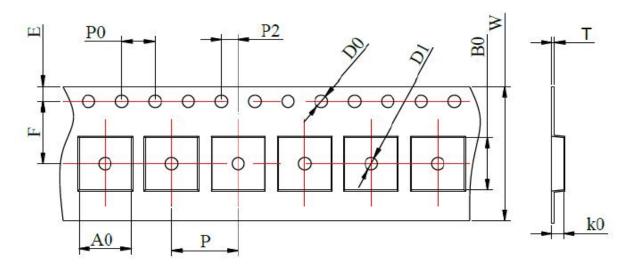






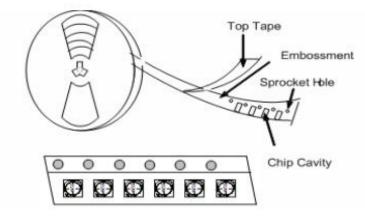
Packaging Information

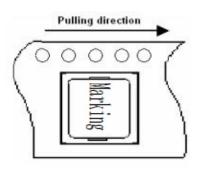
(1) Tape Packaging Dimensions (Unit: mm)



Turpo	Tape dimensions (mm)											
Туре	w	Р	P0	P2	D0	D1	Т	A0	B0	K0	Е	F
WHYT1265	24 ±0.3	16 ±0.1	4.0 ±0.1	2.0 ±0.1	1.5 ±0.1	1.5 ±0.1	0.5 ±0.05	13.1 ±0.1	14 ±0.1	6.8 ±0.1	1.75 ±0.1	11.5 ±0.1

Taping Drawings (UNIT:mm)





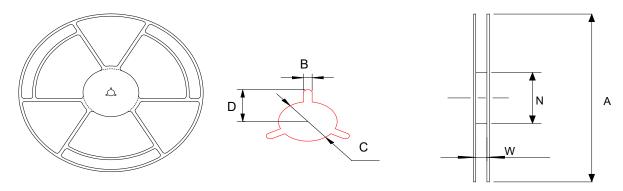






VOOHLi 沃虎

(2) Reel Dimensions (Unit: mm)



A		W	Ν	В	С	D
330+	2.0 2	24±0.5	97±0.5	2.2+0.5	13.0±0.2	10.75±0.25

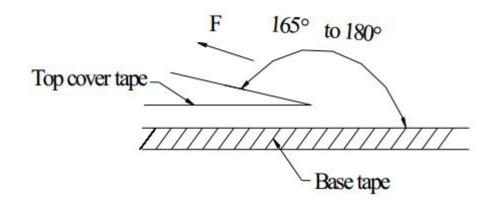
(3) Packaging Quantity(PCS)

Turne	Standard Quantity				
Туре	Reel	Inner box	Carton box		
WHYT1265	500 pcs / reel	2Reel / box (1000 pcs)	4 Middle boxes, (4000 pcs)		

(4) Peel force of top cover tape

The peel speed shall be about 300mm/minute

The peel force of top cover tape shall be between 0.1 to 1.3 N



(5) Reel Label







VOOHU 沃虎



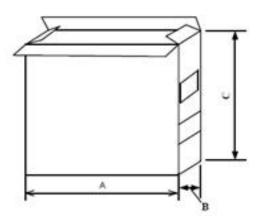
Label on the reel

- Customer's part Number
- Lot Number
- Quantity
- date code

Shipping Label

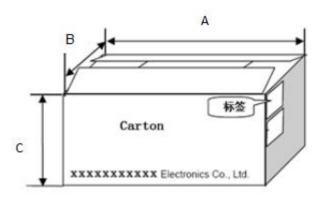
- Customer's part Number
- Manufacturer's part Number
- Quantity
- date code

(6) Inner Box



Packaging type	A (mm)	B (mm)	C (mm)
lnner box	335	70	340

(7) Carton



Packaging type	A (mm)	B (mm)	C (mm)
type	360	360	360





标签

